

# □ MN101C66D, MN101C66G

Type	MN101C66D	MN101C66G	MN101CF66G	MN101CP66D
Internal ROM type	Mask ROM		FLASH	EPROM
ROM (byte)	64K	128K		64K
RAM (byte)	2K	4K		2K
Package (Lead-free)	LQFP080-P-1414A, QFP084-P-1818E	LQFP080-P-1414A (ES (Engineering Sample) available), QFP084-P-1818E	LQFP080-P-1414A, QFP084-P-1818E	
Minimum Instruction Execution Time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8 MHz) 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)* * The lower limit for operation guarantee for flash memory built-in type is 2.5 V. * The lower limit for operation guarantee for EPROM built-in type is 2.3 V.			

## ■ Interrupts

RESET, Watchdog, External 0 to 2, External 3 (LQFP080-P-1414A : Not mounted), External 4 (key interrupt dedicated), Timer 0 to 3, Timer 6, Timer 7 (2 systems), Timer 8 (2 systems), Time base, Serial 0 (2 systems), Serial 2, A/D conversion finish

## ■ Timer Counter

Timer counter 0 : 8-bit × 1

(square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement)

(square-wave/PWM output to large current terminal P50 possible)

Clock source..... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source ..... coincidence with compare register 0

Timer counter 1 : 8-bit × 1

(square-wave output, event count, synchronous output event)

Clock source..... 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/8192, 1/32768 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source ..... coincidence with compare register 1

Timer counter 0, 1 can be cascade-connected.

Timer counter 2 : 8-bit × 1

(square-wave output, additional pulse type 10-bit PWM output, event count, synchronous output event, simple pulse width measurement)

(square-wave/PWM output to large current terminal P52 possible)

Clock source..... 1/2, 1/4 of system clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source ..... coincidence with compare register 2

Timer counter 3 : 8-bit × 1

(square-wave output, event count, generation of remote control carrier, serial 0 baud rate timer)

Clock source..... 1/2, 1/8 of system clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency; external clock input

Interrupt source ..... coincidence with compare register 3

Timer counter 2, 3 can be cascade-connected.

Timer counter 6 : 8-bit freerun timer

Clock source..... 1/1 of system clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock frequency; 1/1, 1/4096, 1/8192 of XI oscillation clock frequency

Interrupt source ..... coincidence with compare register 6

Timer counter 7 : 16-bit × 1

(square-wave output, IGBT/16-bit PWM output (cycle / duty continuous variable), event count, synchronous output event, pulse width measurement, input capture)

(square-wave/PWM output to large current terminal P51 possible)

Clock source..... 1/1, 1/2, 1/4, 1/16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency

Interrupt source ..... coincidence with compare register 7 (2 lines)

**Timer counter 8 : 16 bit × 1**

(square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, inputcapture)  
 (square-wave/PWM output to large current terminal P53 possible)

Clock source..... 1/1, 1/2, 1/4, 1/16, 1/128 of system clock frequency; 1/1, 1/2, 1/4, 1/16, 1/128 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency  
 Interrupt source ..... coincidence with compare register 8 (2 lines)

Timer counters 7, 8 can be cascade-connected.

(square-wave output, PWM, input capture, pulse width measurement is possible as a 32-bit timer.)

**Time base timer (one-minute count setting)**

Clock source..... 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency  
 Interrupt source ..... 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency

**Watchdog timer**

Interrupt source ..... 1/65536, 1/262144, 1/1048576 of system clock frequency

■ **Serial interface**

**Serial 0 : synchronous type/UART (full-duplex) × 1**

Clock source..... 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency

**Serial 2 : synchronous type × 1**

Clock source..... 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency

■ **I/O Pins**

I/O	61 (60)	Common use , Specified pull-up resistor available, Input/output selectable (bit unit) ( ) : LQFP080-P-1414A
Input	4 (3)	Common use , Specified pull-up resistor available ( ) : LQFP080-P-1414A

■ **A/D converter**

10-bit × 8-ch. (with S/H)

■ **Display control function**

LCD

32 segments × 4 commons (static, 1/2, 1/3, or 1/4 duty)

LCD power supply separated from VDD (usable if VLCD ≤ VDD)

LCD power shunt resistance contained

■ **Special Ports**

Buzzer output, remote control carrier signal output, high-current drive port

■ **Electrical Characteristics (Supply current)**

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	fosc = 20 MHz , VDD = 5 V		25	60	mA
	IDD2	fosc = 8 MHz , VDD = 5 V		10	25	mA
	IDD3	fx = 32 kHz , VDD = 3 V		30	100	μA
Supply current at HALT	IDD4	fx = 32 kHz , VDD = 3 V , Ta = 25°C		4	8	μA
	IDD5	fx = 32 kHz , VDD = 3 V , Ta = -40°C to +85°C			30	μA
Supply current at STOP	IDD6	VDD = 5 V , Ta = 25°C			2	μA
	IDD7	VDD = 5 V , Ta = -40°C to +85°C			50	μA

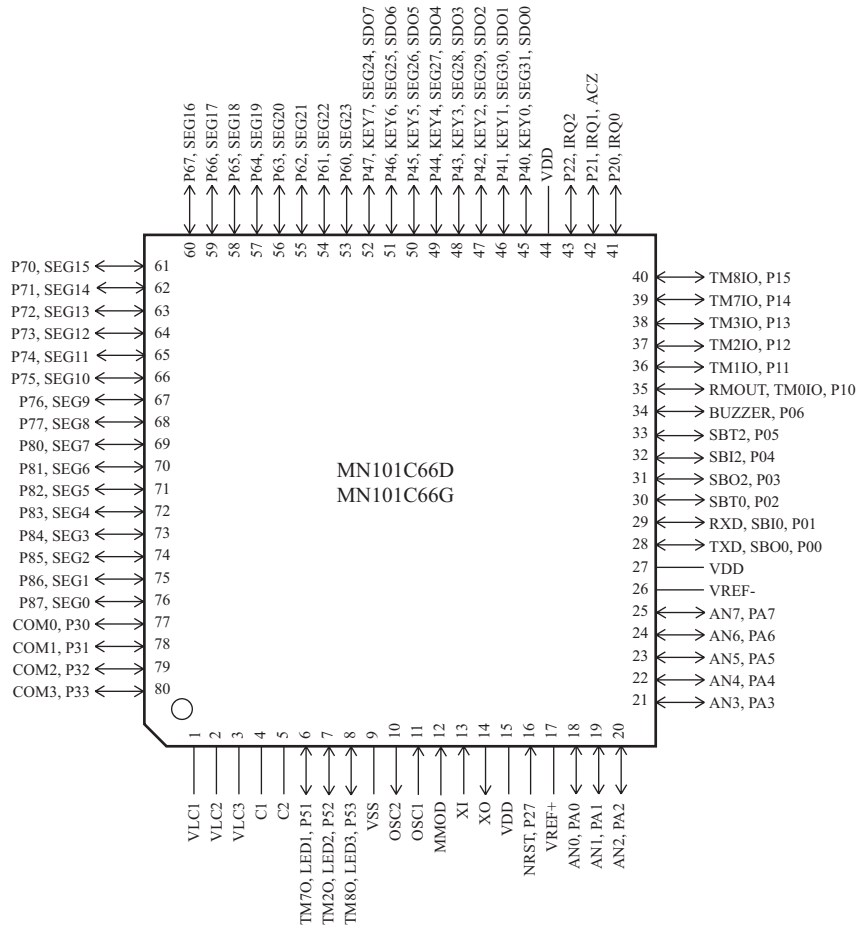
■ **Development tools**

In-circuit Emulator

PX-ICE101C/D+PX-PRB101C66-QFP084-P-1818E-M

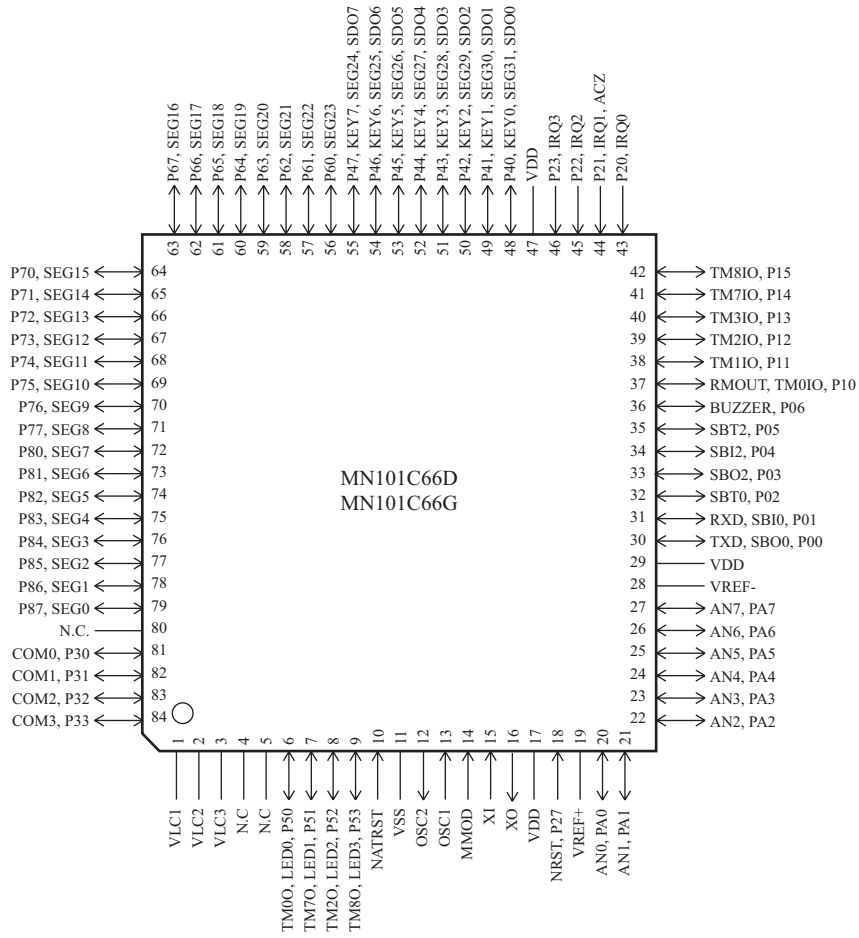
PX-ICE101C/D+PX-PRB101C66-LQFP080-P-1414A-M

## ■ Pin Assignment



LQFP080-P-1414A

■ Pin Assignment



QFP084-P-1818E

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